



#### N-CHANNEL ENHANCEMENT MODE MOSFET

# **Product Summary**

BVsss	Rss(on) Typ	Is Max T <sub>A</sub> = +25°C
12V	$1.34m\Omega$ @ V <sub>GS</sub> = $3.8V$	34A

## **Description**

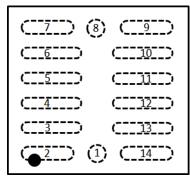
This new generation MOSFET is designed to minimize the on-state resistance (Rss(on)) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Battery Management
- Load Switch
- Battery Protection

## Top View





Source 1: 2, 3, 4, 5, 6, 7

Gate1: 1

Source 2: 9, 10, 11, 12, 13, 14

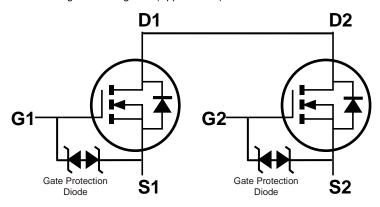
Gate 2: 8

#### **Features**

- CSP with Footprint 3.00mm x 2.74mm
- Height = 0.275mm (Typical) for Low Profile
- ESD Protection of Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

#### **Mechanical Data**

- Case: X2-TSN3027-14
- Terminal Connections: See Diagram Below
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiAu. Solderable per MIL-STD-202, Method 208 (e4)
- Weight: 0.0066 grams (Approximate)



**Equivalent Circuit** 

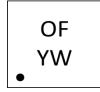
## **Ordering Information** (Note 4)

Part Number	Case	Packaging
DMN11M2UCA14-7	X2-TSN3027-14	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

### **Marking Information**



OF = Product Type Marking Code YW = Date Code Marking Y or  $\overline{Y}$  = Year (ex: 1 = 2021)

W or  $\overline{W}$  = Week (ex: a = Week 27; z Represents Week 52 and 53)

Date Code Key

Da	to odde rtey												
	Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
	Code	1	2	3	4	5	6	7	8	9	0	1	2

Week	1-26	27-52	53
Code	A-Z	a-z	Z

DMN11M2UCA14
Document number: DS43153 Rev. 2 - 2



# **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Source-Source Voltage	Vsss	12	V		
Gate-Source Voltage			$V_{GSS}$	±8	V
0 (	Steady	T <sub>A</sub> = +25°C	Is	34	Α
Continuous Source Current (Note 5) V <sub>GS</sub> = 4.5V	State	T <sub>A</sub> = +70°C		27.5	
	Steady	T <sub>A</sub> = +25°C		25.5	
Continuous Source Current (Note 5) Vgs = 2.5V	State	$T_A = +70$ °C	Is	20	A
Pulsed Source Current (Note 6)	Ism	80	А		

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	P <sub>D</sub>	0.95	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 7)	Reja	132	°C/W
Power Dissipation (Note 5)	P <sub>D</sub>	3.3	W
Thermal Resistance, Junction to Ambient @T <sub>A</sub> = +25°C (Note 5)	R <sub>0JA</sub>	38	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Cumbal	Min	Tim	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	Symbol	IVIII	Тур	Max	Unit	rest Condition	
Source -Source Breakdown Voltage	BVsss	12	_		V	\/aa 0\/ la 1m/	
ÿ						$V_{GS} = 0V$ , $I_{S} = 1mA$	
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	Isss		_	1	μA	$V_{SS} = 10V V_{GS} = 0V$	
Gate-Source Leakage	Igss	-   -	_	±10	μA	$V_{GS} = \pm 8V$ , $V_{SS} = 0V$	
· ·	1655		_	±1	μ, ,	$V_{GS} = \pm 5V$ , $V_{SS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	Vgs(TH)	0.35	0.75	1.4	V	Vss = 10V, $Is = 0.87mA$	
		0.70	1.28	1.85		$V_{GS} = 4.5V$ , $I_{S} = 9.8A$	
Static Source-Source On-Resistance	Dagran	0.75	1.34	2.0	mΩ	$V_{GS} = 3.8V$ , $I_{S} = 9.8A$	
Static Source-Source Off-Resistance	Rss(on)	0.80	1.45	2.38	11122	V <sub>GS</sub> = 3.1V, I <sub>S</sub> = 9.8A	
		0.90	1.65	3.40		$V_{GS} = 2.5V, I_S = 9.8A$	
Diode Forward Voltage	Vss	_	_	1.0	V	V <sub>G</sub> S = 0V, I <sub>S</sub> = 9.8A	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	6083	_		.,	
Output Capacitance	Coss	_	1421	_	pF	$V_{SS} = 6V, V_{GS} = 0V,$ f = 1.0kHz	
Reverse Transfer Capacitance	C <sub>rss</sub>		304	_		1 = 1.0KHZ	
Total Gate Charge	Qg		71	_			
Gate-Source Charge	Q <sub>gs</sub>		12	_	nC	$V_{DD} = 6V$ , $V_{GS} = 4V$ ,	
Gate-Drain Charge	Q <sub>gd</sub>		17	_	IIC	Is = 9.8A	
Gate Charge at VTH	Q <sub>g(TH)</sub>		7	_			
Turn-On Delay Time	td(ON)	_	0.9	_			
Turn-On Rise Time	t <sub>R</sub>	_	1.7	_	μs	$V_{DD} = 6V$ , $V_{GS} = 4V$ ,	
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	4.0	_	μδ	$I_S = 9.8A$	
Turn-Off Fall Time	tF		3.6	_			

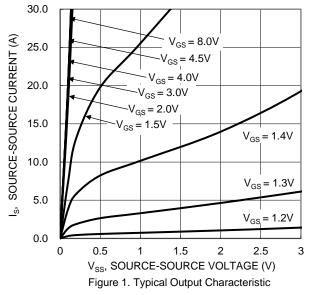
Notes:

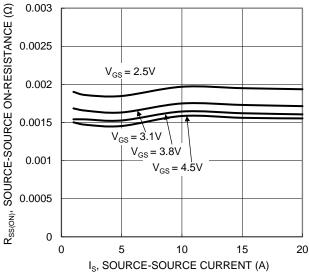
- 5. Device mounted on FR-4 material with 1inch² (6.45cm²), 2oz. (0.071mm thick) Cu.
- Repetitive rating, pulse width limited by junction temperature.

   Device mounted on FR-4 PCB with minimum recommended pad layout, single sided.
- S. Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to production testing.

DMN11M2UCA14 2 of 7 May 2021 © Diodes Incorporated Document number: DS43153 Rev. 2 - 2







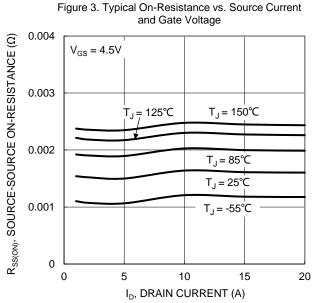


Figure 5. Typical On-Resistance vs. Source Current and Junction Temperature

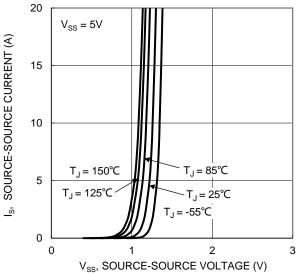
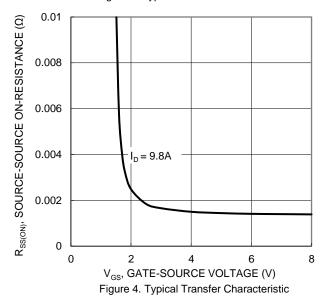


Figure 2. Typical Transfer Characteristic



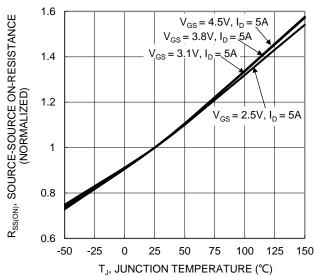


Figure 6. On-Resistance Variation with Junction Temperature



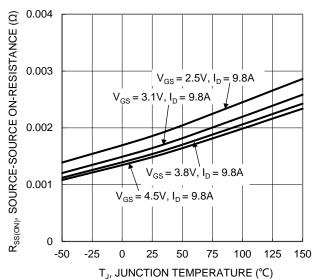
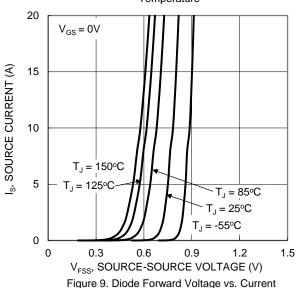


Figure 7. On-Resistance Variation with Junction Temperature



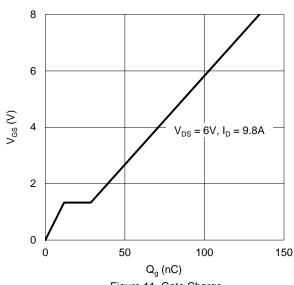
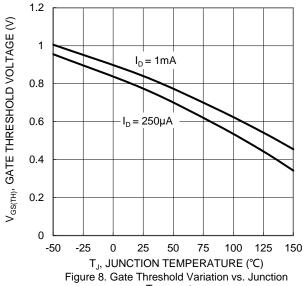
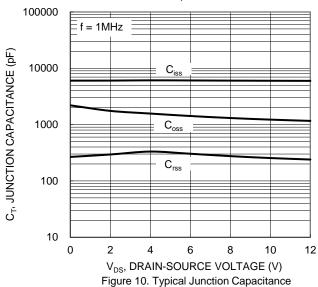


Figure 11. Gate Charge



Temperature



1000 R<sub>DS(ON)</sub> Limited  $P_W = 100 \mu s$ 100 w = 1ms SOURCE CURRENT (A) 10 = 10ms  $P_{W} = 100 ms$  $T_{J(Max)} = 150$ °C  $T_A = 25^{\circ}C$ Single Pulse DC DUT on 1\*MRP Board = 4.5 V0.01 0.01 10 100 V<sub>SS</sub>, SOURCE-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



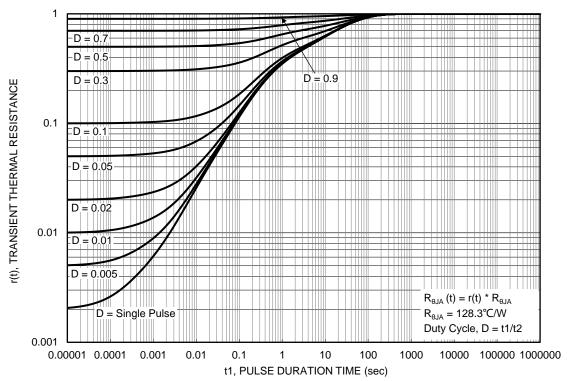


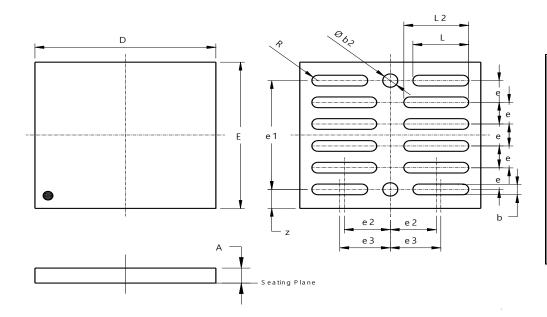
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-TSN3027-14

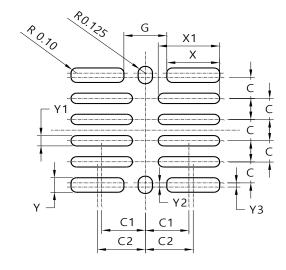


X2-TSN3027-14							
Dim	Min	Max	Тур				
Α	0.245	0.305	0.275				
b	0.17	0.23	0.20				
b2	0.22	0.28	0.25				
D	2.95	3.05	3.00				
Е	2.69	2.79	2.74				
е			0.406				
e1			2.03				
e2			0.7625				
<b>e</b> 3		-	0.8375				
١	0.895	0.955	0.925				
L2	1.045	1.105	1,075				
Z			0.355				
R	0.10REF						
All Dimensions in mm							

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### X2-TSN3027-14



Dimensions	Value (in mm)
С	0.406
C1	0.7625
C2	0.8375
G	0.450
Х	0.925
X1	1.075
Υ	0.280
Y1	0.200
Y2	0.085
Y3	0.080



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7 of 7 DMN11M2UCA14 Document number: DS43153 Rev. 2 - 2

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